



# Coilmaster



RoHS Compliant

## SPECIFICATION APPROVAL

CUSTOMER : Ivent

PRODUCT : SDC104R-470N-LF

Pb-free

CODE NO. : C00910060

CUS. CODE :

SPEC.NO. : C-0910-060(03)

DATE : 27-Sep-06

CUSTOMER APPROVAL

**Coilmaster Electronics Co., Ltd.**

9F-3,NO.398 HUAN BEI ROAD, CHUNG-LI CITY

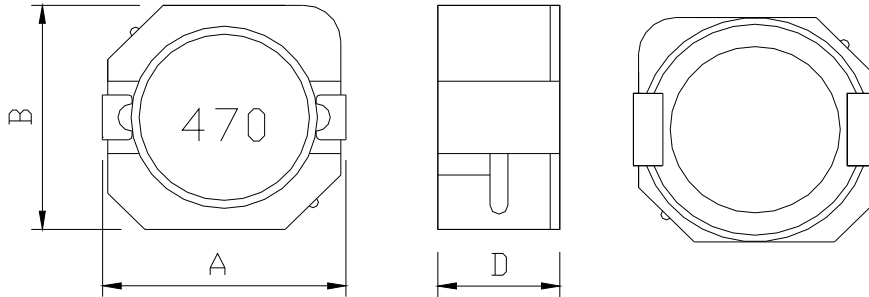
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PREPARED BY	APPROVED BY	AUTHORIZED BY
JEAN	TONY	MASCOT

PRODUCT	SDC104R-470N-LF	<b>COIL SPECIFICATION</b>	DATE	2006/9/27
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**EXTERNAL DIMENSIONS :**

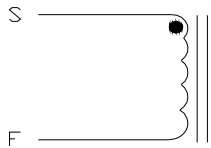


A : 10.5 Max. m/m  
 B : 10.3 Max. m/m  
 D : 4.0 Max. m/m

**ELECTRICAL CHARACTERISTIC :**

L( $\mu$ H) : 47 $\pm$ 30% 100KHz 0.25V  
 DCR(m $\Omega$ ) : 128 Max.  
 IDC(A) : 2.10 Max. ( L2.1A MAX  $\geq$  0Ax65% )  
 INDUCTANCE DROP : 35% MAX @ IDC 2.1 A  
 Operation Temperature Range : -40 $^{\circ}$ C to +125 $^{\circ}$ C.

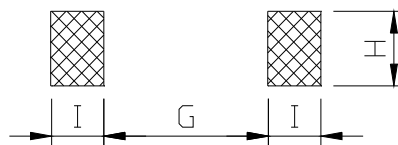
**SCHEMATIC DRAWING :**



$\phi$  0.28x19.5Ts (Ref.)

"●" START FOR STAND

**PCB PATTERN :**



G: 7.3 m/m  
 H: 3.2 m/m  
 I: 1.6 m/m

**MATERIAL LIST :**

NO	ITEM	MATERIAL	SUPPLIER OF THE MATERIAL
1	CORE	DL5 DR9.6*3.7D-3 B4.8 F1.9 DL5 SRI10*8.2*3.2	
2	WIRE	$\phi$ 0.28 2SFFW(180 $^{\circ}$ C)	
3	BASE	C-104R-2H(红铜)	
4	EPOXY	H210(固定DR与RI) ; 3622C(接著BASE)	

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**TEST DATA**

ELECTRICAL CHARACTERISTICS							
MEAS. ITEM	L(μH)	DCR(mΩ)	IDC(A)				
TEST FREQ.	100KHz 0.25V	Max.	Max.				
YOUR			L(2.1A)				
SPEC.	47±30%	128	≥ 0Ax65%				
1	42.82	115.45	35.54				
2	42.50	114.35	35.27				
3	40.00	115.80	33.53				
4	4.00	115.32	34.81				
5	41.94	114.70	35.21				
6	42.43	114.61	35.69				
7	43.01	115.05	34.31				
8	41.38	115.46	35.35				
9	42.60	114.83	35.88				
10	43.23	115.02	34.51				
X	<b>38.391</b>	<b>115.059</b>	<b>35.010</b>				
R	<b>39.23</b>	<b>1.45</b>	<b>2.35</b>				

DIMENSION							
MEAS. ITEM	A	B	C	D			
TEST FREQ.	m/m	m/m	m/m	m/m			
YOUR							
SPEC.	10.5 Max.	10.3 Max.		4.0 Max.			
1	10.26	10.07		3.83			
2	10.20	10.16		3.82			
3	10.24	10.15		3.84			
4	10.21	10.12		3.81			
5	10.20	10.15		3.85			
6							
7							
8							
9							
10							
X	<b>10.222</b>	<b>10.130</b>		<b>3.830</b>			
R	<b>0.06</b>	<b>0.09</b>		<b>0.04</b>			

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TEST ITEMS	SPECIFICATIONS	TEST CONDITIONS / TEST METHODS		
<b><u>ELECTRICAL PERFORMANCE TEST</u></b>				
L	REFER TO STANDARD ELEC-TRICAL CHARACTERISTIC LIST.	CH-1061 OR EQUIV.		
DCR		CH-502A OR EQUIV		
RATED CURRENT		APPLIED THE CURRENT TO COILS THE IDUCTANCE CHANGE SHOULD BE LESS THAN 35% TO INITIAL VALUE AND TEMPERATURE RISE SHOULD NOT BE MORE THAN 40°C..		
TEMPERATURERISE TEST		40°C MAX ( $\Delta t$ )	1. APPLIED THE ALLOWED DC CURRENT FOR 4 HOURS. 2. TEMPERATURE MEASURE BY DIGITAL SURFACE THERMOMETER.	
OVER LOAD TEST	NO EVIDENCE OF ELECTRICAL DAMAGE	APPLIED 1.5 TIMES OF RATED ALLOWED DC CURRENT TO INDUCTORS FOR A PERIOD OF 5 MINUTES.		
<b><u>MECHANICAL PERFORMANCE TEST</u></b>				
SOLDER HEAT RESISTANCE	1. INDUCTORS SHOULD HAVE NO EVIDENCE OF ELEC- TRICAL AND MICHANICAL DAMAGE 2. INDUCTANCE SHOULD NOT HANGE MORE THAN $\pm 10\%$ 3. SOLDER MATERIAL WILL BE LEAD FREE.	PREHEAT:150°C 60SECS		
		SOLDER TEMPERATURE: 255 $\pm 5$ °C		
		FLUX: ROXIN.. DIP TIME:10 $\pm 0.5$ SECS.		
VIBRATION TEST (LOW FREQUENCY)				
SHOCK TEST		1.AMPLITUDE: 1.5 mm 2.FREQUENCY: 10-55-10HZ / 1 MIN 3.DIRECTION: X, Y, Z 4.DURATION: 2 HRS/X, Y, Z INDUCTORS SHOULD BE DROPPED 10 TIMES FROM A HEIGHT OF 1m ONTO 3cm WOODEN BOARD.		

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**MECHANICAL PERFORMANCE TEST**

SOLDERABILITY TEST	MORE THAN 90% OF TERMINAL ELECTRODE SHOULD BE COVERED WITH SOLDER.	AFTER FLUXING, INDUCTOR SHALL BE DIPPED IN A MELTED SOLDER BATH AT 255±5°C FOR 5 SECONDS	
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COMPONENT ADHESION ( PUSH TEST )	1.5Kg Min	THE DEVICE SHOULD BE REFLOW SOLDERED ( 255±5°C FOR 10 SECONDS ) TO A TINNED COPPER SUBSTRATE. A DYNAMETER FORCE GAUGE SHOULD BE APPLIED TO THE SIDE OF THE COMPONENT. THE DEVICE MUST WITH- STAND A MINIMUM FORCE OF 1.5Kg WITHOUT AILURE OF THE TERMINATION . ATTACHED TO COMPONENT.	
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COMPONENT ADHESION ( PULL TEST )	1.5Kg Min	1.INSERT 10cm WIRE INTO THE REMAINING OPEN EYE BEND THE ENDS OF EVEN WIRE LENGTHS UPWARD AND WIND TOGETHER 2. TERMINAL SHALL NOT BEREMARKABLY DAMAGED	
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FLEXTURE STRENGTH	THE FORCES APPLIED SHOULD NOT DAMAGE THE DIELECTRIC.	SOLDER A CHIP ON A TEST SUBSTRATE, BEND THE SUBSTRATE BY 2mm AND RETURN.	
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RESISTANCE TO SOLVENT TEST	THERE SHOULD BE NO CASEDEFORMATION, CHANGE IN APPEARANCE OR BITERATION OF MARKING	INDUCTERS SHALL WITHSTAND 6 MINTES OF ALCOHOL	
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**CLIMATIC TEST**

TEMPERATURE CHARACTERISTIC	1.APPEARANCE:NO DAMAGE 2.INDUCTANCE:WITHIN±10% OF INITIAL VALUE.	- 40°C ~ +125°C	
HUMIDITY TEST		60°C±2°C / 96±2 HOURS	
LOW TEMPERATURE STORAGE		1.TEMPERATURE:- 25°C±2°C 2.TIME: 96±2 HOURS	
THERMAL SHOCK TEST		1.-25±5°C FOR 30 MINUTES. +80±5°C FOR 30 MINUTES. 2.TOTAL: 10 CYCLES	
HIGH TEMPERATURE STORAGE		1.APPLIED CURRENT: MAX RATED CURRENT 2.TEMPERATURE:80°C±2°C	

NOTE : INDUCTORS ARE TO BE TESTED AFTER 2 HOUR AT ROOM TEMPERATURE.

**LIFE TEST**

HIGH TEMPERATURE LOAD LIFE TEST	INDUCTORS SHOULD BE NO EVIDENCE OF SHORT OR OPEN CIRCUIT	1. TEMPERATURE: 80±2°C 2. TIME: 500±12 HOURS 3. LOAD: ALLOWED DC CURREN
HUMIDITY LOAD LIFE TEST		1. TEMPERATURE: 60±2°C 2. R.H.: 90-95% 3. TIME: 500±12 HOURS 4. LOAD: ALLOWED DC CURREN

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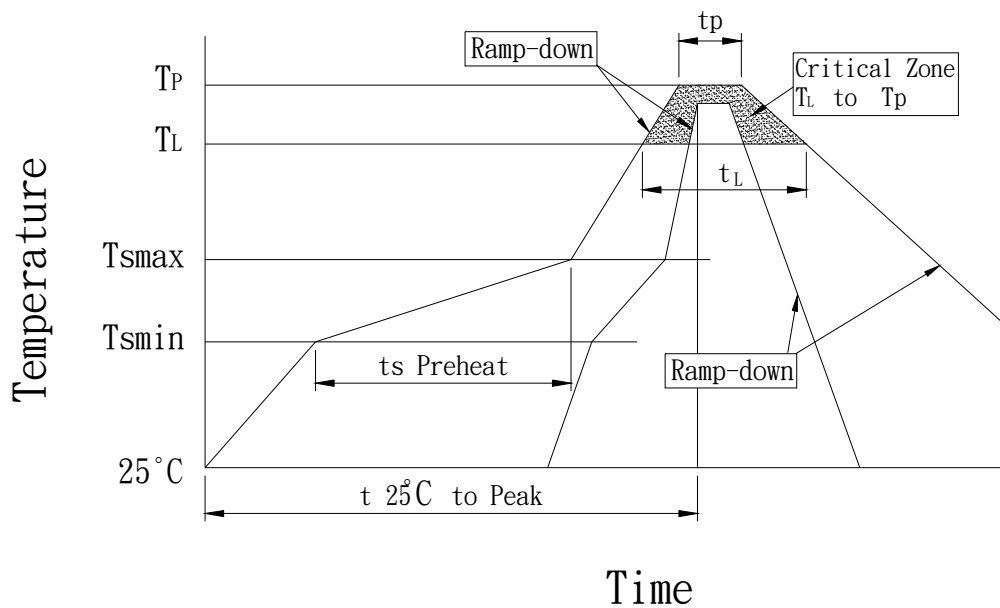
**RECOMMENDED SOLDERING CONDITIONS :**

CLASSIFIC

Profile Feature	Sn-Pb Eutectic Assembly		Pb-Free Assembly	
	Large Body	Small Body	Large Body	Small Body
Average ramp-up rate ( $T_L$ to $T_P$ )	3°C/second max.		3°C/second max.	
Preheat				
-Temperature Min ( $T_{smin}$ )	100°C		150°C	
-Temperature Min ( $T_{smax}$ )	150°C		200°C	
-Time (min to max) (ts)	60-120 seconds		60-180 seconds	
$T_{smax}$ to $T_L$				
-Ramp-up Rate			3°C/second max.	
Time maintained above:				
-Temperature ( $T_L$ )	183°C		217°C	
-Time ( $t_L$ )	60-150 seconds		60-150 seconds	
Peak Temperature ( $T_P$ )	225 +0/-5°C	240 +0/-5°C	245 +0/-5°C	255 +5/-5°C
Time within 5°C of actual Peak Temperature ( $t_p$ )	10-30 seconds	10-30 seconds	10-30 seconds	20-40 seconds
Ramp-down Rate	6°C/second max.		6°C/second max.	
Time 25°C to Peak Temperature	6 minutes max.		8 minutes max.	

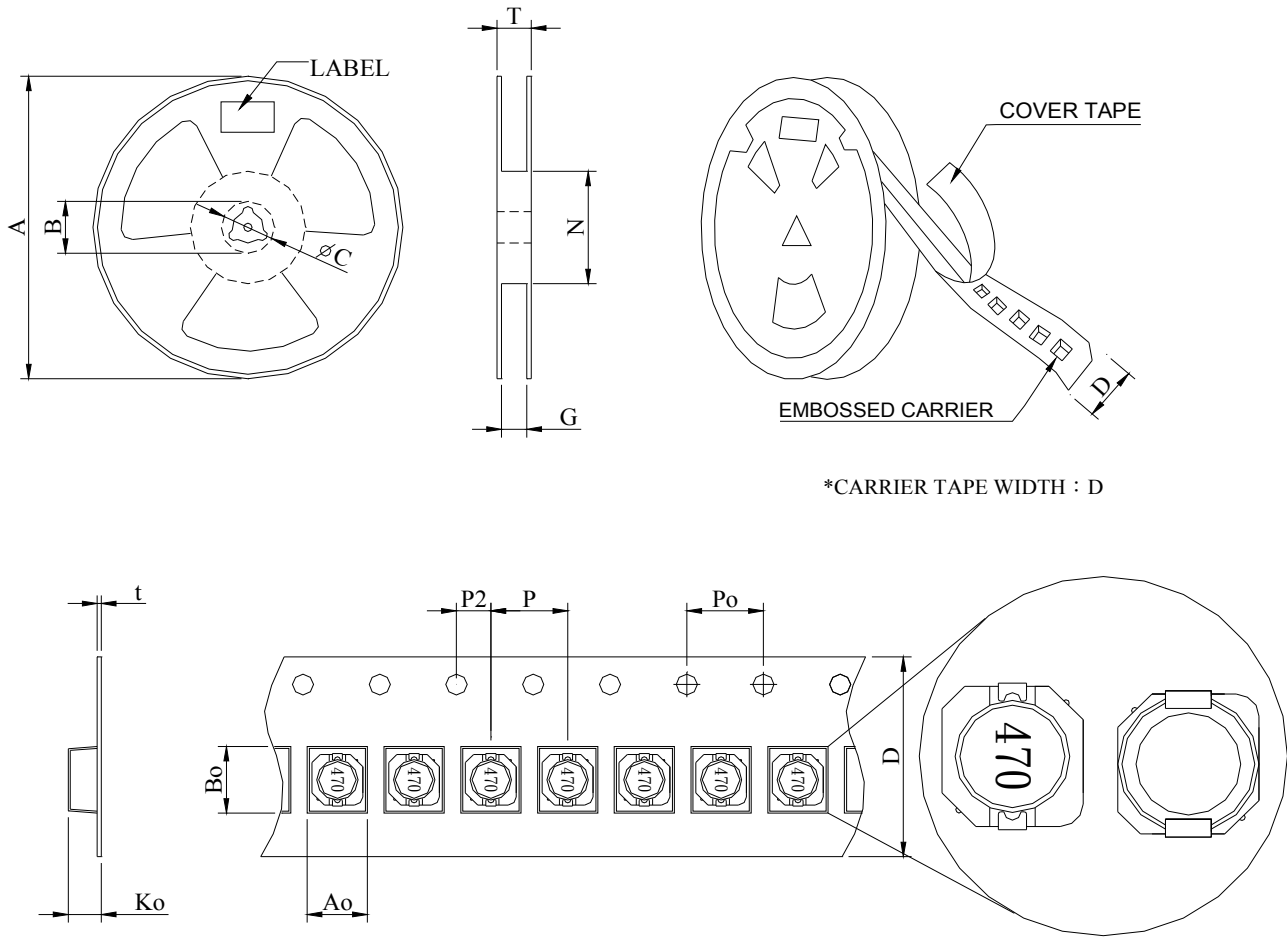
Note : All temperatures refer to topside of the package. Measured on the package body surface.

REFLOW SOLDERINGS



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**PACKAGE :**



\*CARRIER TAPE WIDTH : D

(將REEL帶插入卷盤軸的洞裡)  
(fold the end of the plastic into the package)



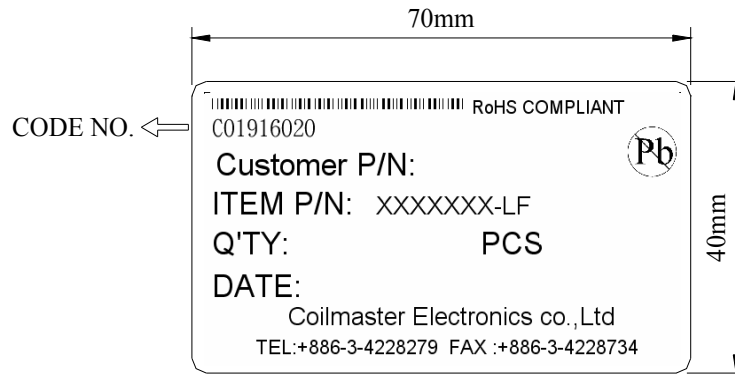
STYLE	DIMENSIONS (m/m)														
	Q'TY (PCS)	A	B	C	D	G	N	T	Ao	Bo	Ko	t	P	Po	P2
13'	1000	330	—	15.5 ±0.5	24.0 ±0.3	24	75.0 ±2.0	—	10.9 ±0.2	11.0 ±0.2	4.2 ±0.1	0.4 ±0.05	16.0 ±0.1	4.0 ±0.1	2 ±0.05

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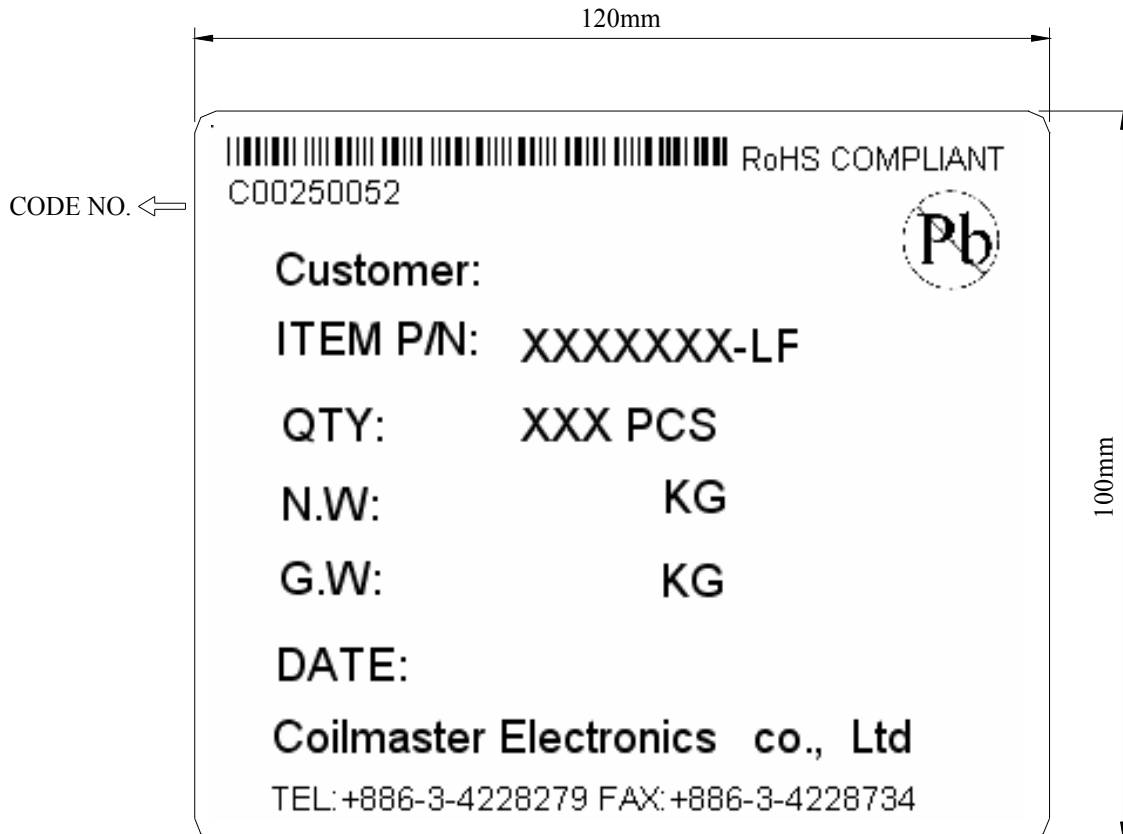


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TABLE :



INNER BOX LABEL



OUT BOX LABEL

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